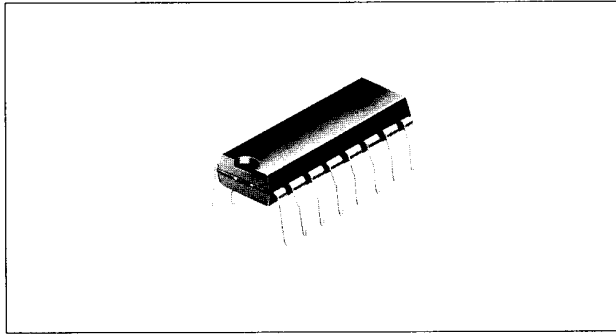


# BA12003 BA12004



### Dimensions (Unit: mm)

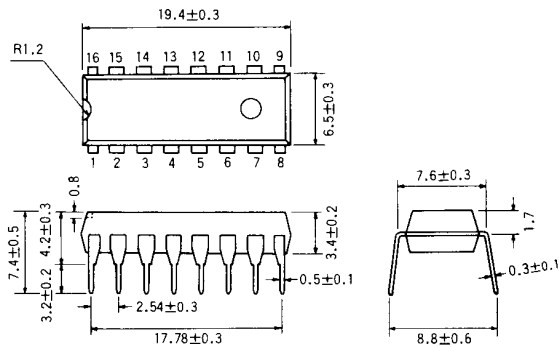


Fig. 1

The BA12003 and BA12004 are high-voltage, high-current transistor arrays each containing seven Darlington transistors. With internal surge suppressors and base current limiting resistor for inductive load driving (such as relay coils), the devices require few external components. Also featuring high output voltage (50 V) and high output sink current (500 mA), the BA12003 and BA12004 are suited for interfacing with other drivers and power devices.

### Features

1. High output sink current ( $I_{OUT}=500$  mA max.).
2. High output voltage ( $V_{OUT}=50$  V max.).
3. Seven Darlington transistor arrays implemented on a single chip.
4. Internal surge suppressor in output stage.
5. Pin-compatible with the XR-2203/ XR-2204 by EXAR and the  $\mu$ PA2003C/ $\mu$ PA2004C by NEC.

### Applications

LED, lamp, relay and solenoid drivers  
Device interface

### Block Diagram

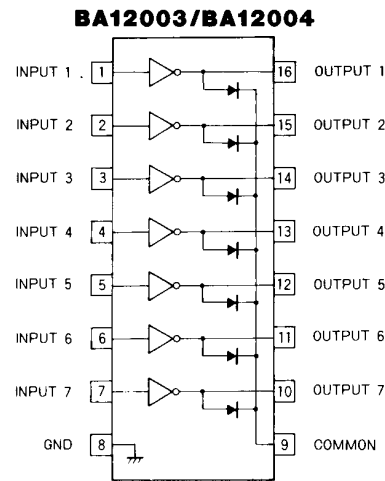


Fig. 2

### Absolute Maximum Ratings ( $T_a=25^\circ\text{C}$ )

Parameter	Symbol	Limits	Unit
Supply voltage	$V_{CE}$	50	V
Power dissipation	$P_d$	$1100^{*1}$	mW
Operating temperature range	$T_{opr}$	$-25 \sim 75$	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	$-55 \sim 125$	$^\circ\text{C}$
Input voltage	$V_{IN}$	$-0.5 \sim 30$	V
Output current	$I_{OUT}$	500	mA/unit
Ground pin current	$I_{GND}$	$2.3^{*2}$	A
Diode reverse voltage	$V_R$	60	V
Diode forward current	$I_F$	500	mA

\*1 Derating is done at  $11\text{mW}/^\circ\text{C}$  for operation above  $T_a=25^\circ\text{C}$ .

\*2 Pulse width  $\leq 20\text{ms}$ , duty cycle  $\leq 10\%$ , same current through 7 circuits.

### Circuit Diagrams

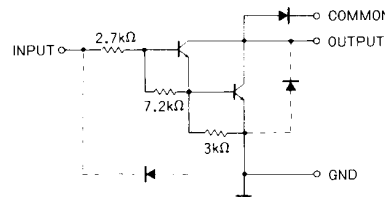


Fig. 3 1/7 BA12003 circuit

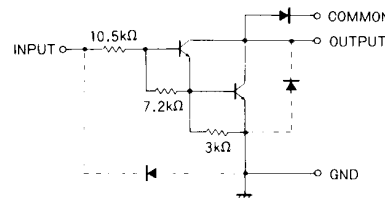


Fig. 4 1/7 BA12004 circuit

## Recommended Operating Conditions (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Output current	$I_{OUT}$	—	—	350	mA	Refer to Figs. 8, 9
Supply voltage	$V_{CE}$	—	—	50	V	—
Input voltage	$V_{IN}$	-0.5	—	30	V	—
Power dissipation	$P_d$	—	—	1100	mW	Refer to Fig. 7

## Electrical Characteristics (Unless otherwise specified, Ta=25°C)

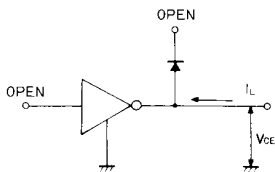
Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions	Test circuit
Output leakage current	$I_L$	—	—	10	$\mu A$	$V_{CE}=50V$	Fig. 5
DC forward current transfer ratio	$h_{FE}$	1000	—	—	—	$V_{CE}=2.0V, I_{OUT}=350mA$	Fig. 5
Output saturation voltage	$V_{CE(sat)}$	—	—	1.1	V	$I_{OUT}=100mA, I_{IN}=250\mu A$	Fig. 5
Output saturation voltage	$V_{CE(sat)}$	—	—	1.3	V	$I_{OUT}=200mA, I_{IN}=350\mu A$	Fig. 5
Output saturation voltage	$V_{CE(sat)}$	—	—	1.6	V	$I_{OUT}=350mA, I_{IN}=500\mu A$	Fig. 5
Input voltage	$V_{IN}$	—	—	2.0(5.0)	V	$V_{CE}=2.0V, I_{OUT}=100mA$	Fig. 5
Input voltage	$V_{IN}$	—	—	2.4(6.0)	V	$V_{CE}=2.0V, I_{OUT}=200mA$	Fig. 5
Input voltage	$V_{IN}$	—	—	3.4(8.0)	V	$V_{CE}=2.0V, I_{OUT}=350mA$	Fig. 5
Input current	$I_{IN}$	BA12003	—	1.35	mA	$V_{IN}=3.85V$	Fig. 5
		BA12004	—	0.5		$V_{IN}=5.0V$	
Diode reverse current	$I_R$	—	—	50	$\mu A$	$V_R=50V$	Fig. 5
Diode forward voltage	$V_F$	—	—	2.0	V	$I_F=350mA$	Fig. 5
Input capacity	$C_{IN}$	—	70	—	pF	$V_{IN}=0, f=1MHz$	Fig. 5

Values within ( ) are for BA12003

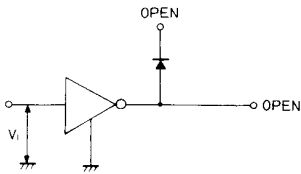
Drivers

## Test Circuits

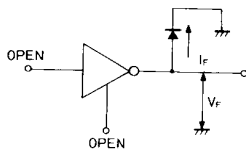
1) Output leakage current  $I_L$



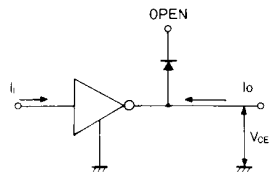
4) Input current  $I_{IN}$



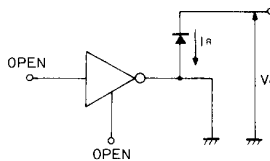
6) Diode forward voltage  $V_F$



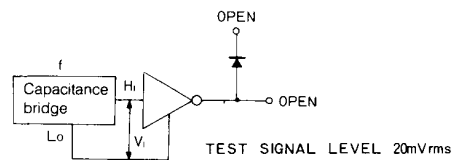
2) DC forward current transfer ratio  $h_{FE} = \frac{I_O}{I_I}$   
Output saturation voltage  $V_{CE(sat)}$



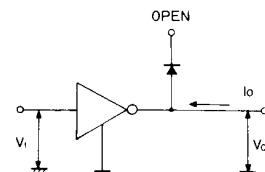
5) Diode reverse current  $I_R$



7) Input capacity  $C_{IN}$



3) Input voltage  $V_{IN}$



## Application Examples

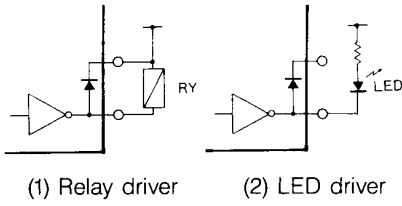


Fig. 6

The BA12003 is directly interfaceable with TTL and CMOS devices (operating at 5 V). To limit input current to the safety range, each input has an internal series resistor. The BA12004 is designed for direct interface with CMOS or PMOS devices operating on 6 to 15 V. To limit input current to the safety range, each input has an internal series resistor. The load should be connected across the

driver output and power source. To protect the device from transient spikes, pull the COM pin (pin 9) up to the power supply.

## Electrical Characteristic Curves (BA12003)

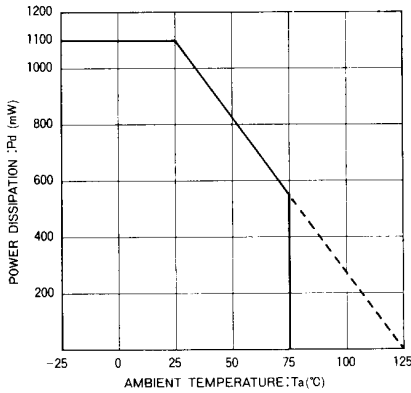


Fig. 7 Power dissipation vs. ambient temperature

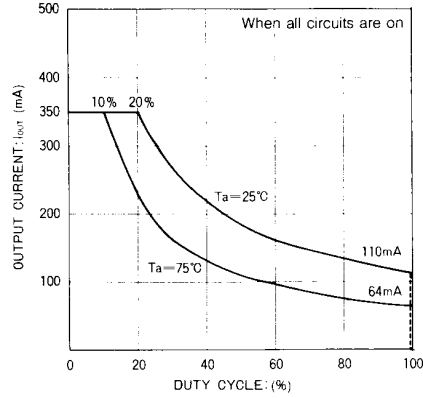


Fig. 8 Output current vs. duty cycle

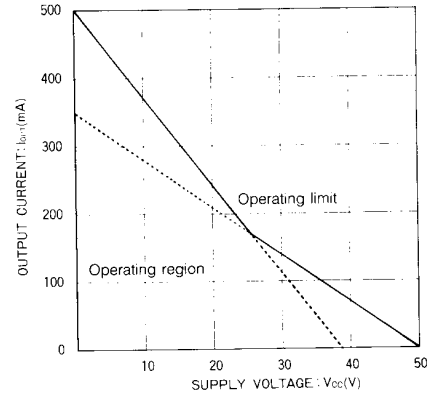


Fig. 9 Output current vs. supply voltage

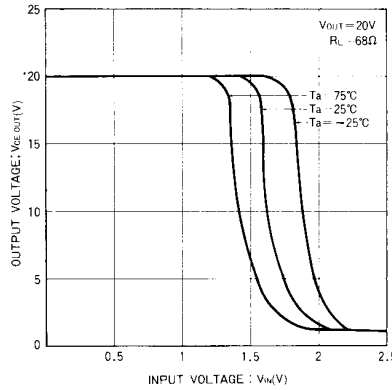


Fig. 10 Output voltage vs. input voltage

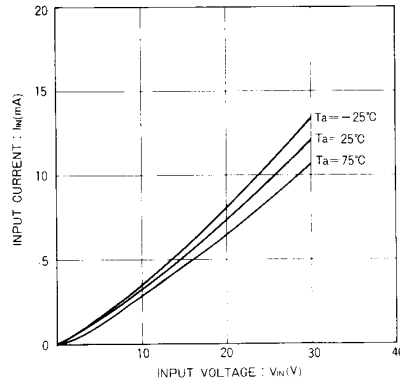


Fig. 11 Input current vs. input voltage

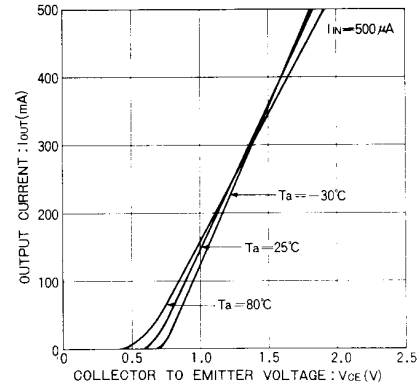


Fig. 12 Output current vs. collector to emitter voltage

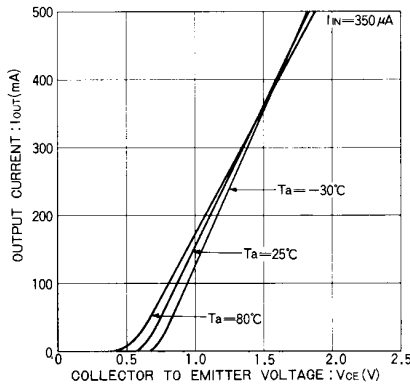


Fig. 13 Output current vs. collector to emitter voltage

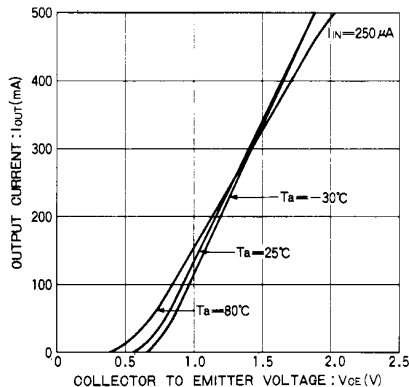


Fig. 14 Output current vs. collector to emitter voltage

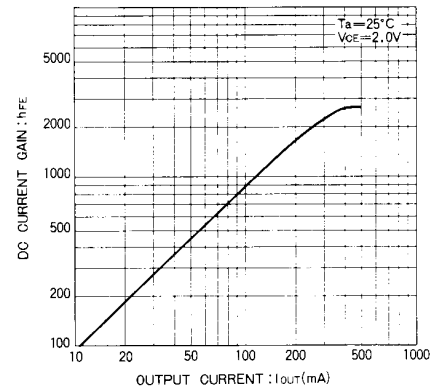


Fig. 15 DC current gain vs. output current

## Electrical Characteristic Curves (BA12004)

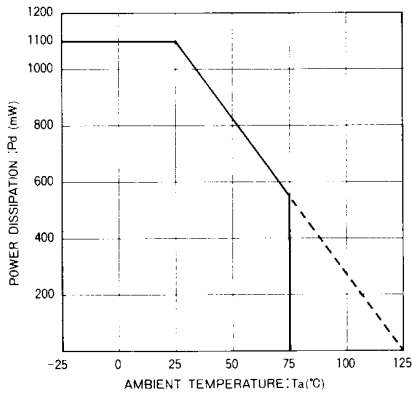


Fig. 16 Power dissipation vs. ambient temperature

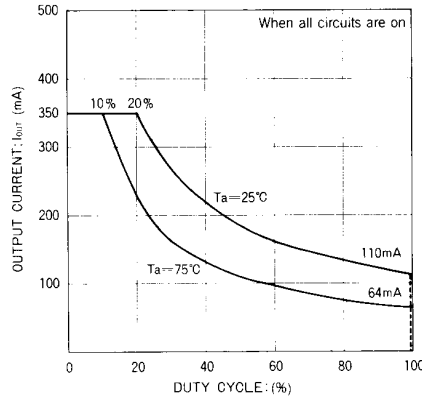


Fig. 17 Output current vs. duty cycle

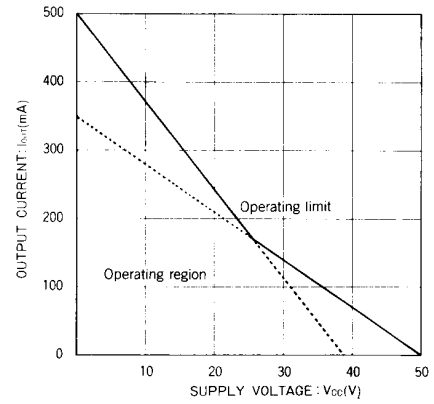


Fig. 18 Output current vs. supply voltage

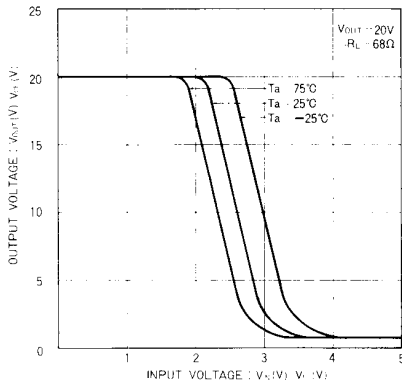


Fig. 19 Output voltage vs. input voltage

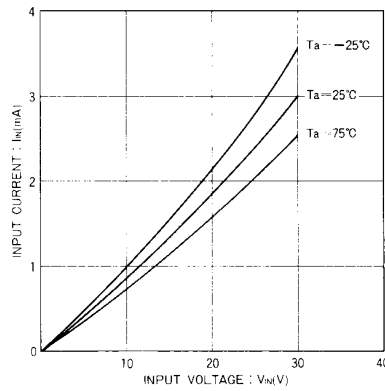


Fig. 20 Input current vs. input voltage

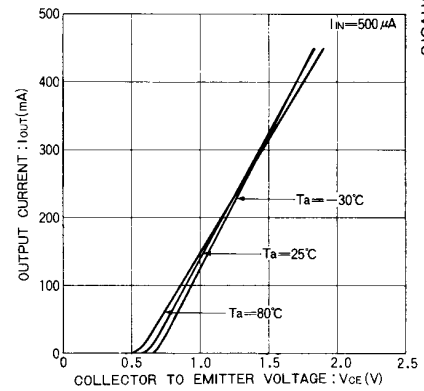


Fig. 21 Output current vs. collector to emitter voltage

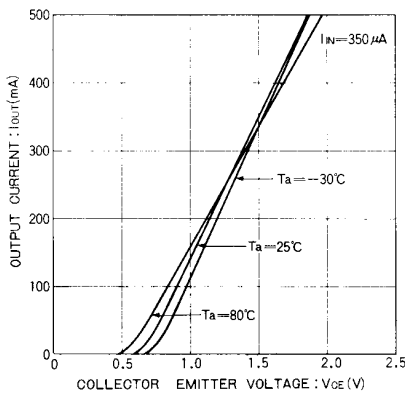


Fig. 22 Output current vs. collector to emitter voltage

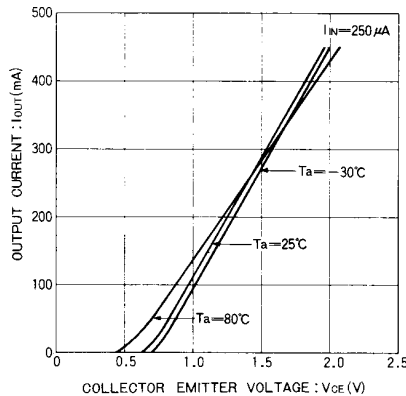


Fig. 23 Output current vs. collector to emitter voltage

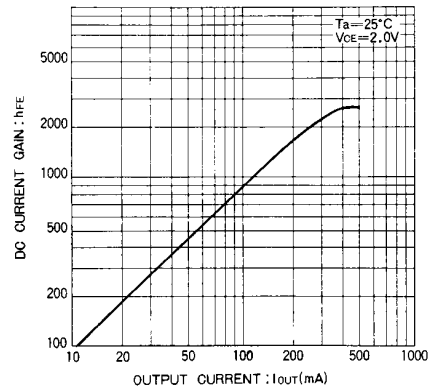


Fig. 24 DC current gain vs. output current

Drivers